



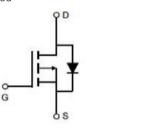
MJ P-Channel Super Trench Power MOSFET

Description

The MJXP40PT15D uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of R_{DS(ON)} and Q_g. This device is ideal for high-frequency switching and synchronous rectification.

General Features

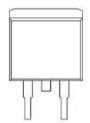
- Φ V_{DS} =-40V,I_D =-150A R_{DS(ON)}=2.8mΩ (typical) @ V_{GS}=-10V R_{DS(ON)}=3.8mΩ (typical) @ V_{GS}=-4.5V
- ◆ Excellent gate charge x R_{DS(on)} product(FOM)
- ◆ Very low on-resistance R_{DS(on)}
- ◆ 175 °C operating temperature
- ◆ Pb-free lead plating
- ♦ 100% UIS tested

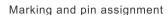




Application

- ◆ DC/DC Converter
- ♦ Ideal for high-frequency switching and synchronous rectification







TO-263-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJXP40PT15D	MJXP40PT15D	TO-263-2L	4	-	-

Absolute Maximum Ratings (Tc =25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-150	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	-120	А
Pulsed Drain Current	Ідм	-600	А
Maximum Power Dissipation	PD	250	W
Derating factor		1.67	W/°C
Single pulse avalanche energy (Note 5)	Eas	1345	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rөjc	0.6	°C/W
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Electrical Characteristics (Tc =25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250µA	-40	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =-40V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	_	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	Vos=Vgs ,Io=-250µA	-0.8	-1.2	-1.8	V
		V _{GS} =-10V, I _D =-75A	-	2.8	3.4	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =-4.5V, I _D =-75A	-	3.8	4.6	mΩ
Forward Transconductance	grs	V _{DS} =-5V,I _D =-75A	-	30	-	s
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss	V _{DS} =-20V,V _{GS} =0V F=1.0MHz	-	8940	-	PF
Output Capacitance	Coss		-	1900		PF
Reverse Transfer Capacitance	Crss	•	-	45	-	PF
Switching Characteristics (Note 4)	'					
Turn-on Delay Time	t _{d(on)}	V _{DD} =-20V,I _D =-75A	-	18	-	nS
Turn-on Rise Time	tr		-	13	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =1.6Ω	_	90	-	nS
Turn-Off Fall Time	tf		-	15	-	nS
Total Gate Charge	Qg		-	104.4	-	nC
Gate-Source Charge	Qgs	V _{DS} =-20V,I _D =-75A V _{GS} =-10V	-	20.8	-	nC
Gate-Drain Charge	Q _{gd}		_	13.5	_	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =-75A	-	-	-1.2	V
Diode Forward Current (Note 2)	ls		-	-	-150	А
Reverse Recovery Time	trr	T1-25°0 1- 75^	_	-	35	nS
Reverse Recovery Charge		TJ=25°C, IF=-75A di/dt=100A/µs (Note 3)				nC

Notes:

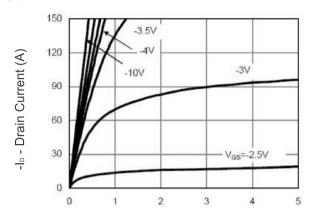
- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production



-I_o - Drain Current (A)



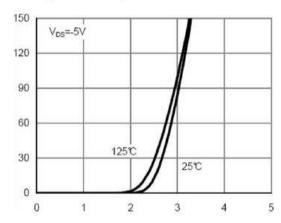
Typical Electrical and Thermal Characteristics



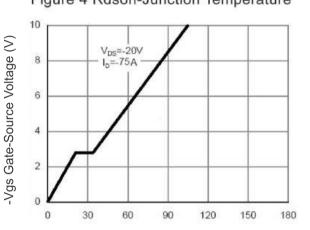
2 Normalized On-Resistance 1.8 V_{GS}=10V I_D=-75A 1.6 1.4 1.2 √_{es}=4.5∨ I_p=-75A 1 8.0 25 75 100 125 150 175

-Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics

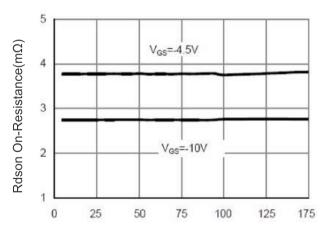


TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature

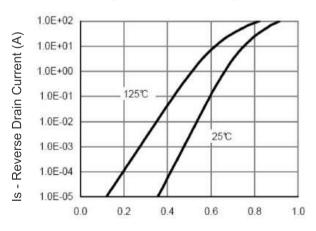


-Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics



Qg Gate Charge (nC)
Figure 5 Gate Charge



I⊳ - Drain Current (A)

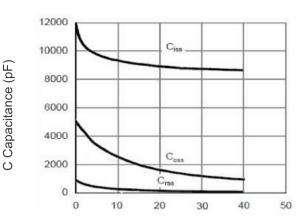
Figure 3 Rdson- Drain Current

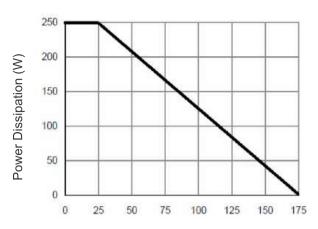
Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward



-lo - Drain Current (A)







Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

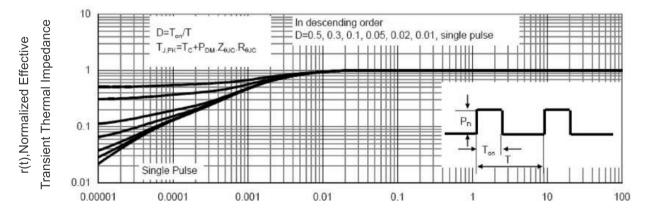
1000.0 100.0 10µs limited 100µs 10.0 1ms DC 10ms 1.0 0.1 T_{J(Max)}=175℃ T_c=25℃ 0.0 0.01 0.1 1 10 100

-Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T_J -Junction Temperature(°C) Figure 9 Power De-rating



T_J -Junction Temperature(°C)
Figure 10 Current De-rating



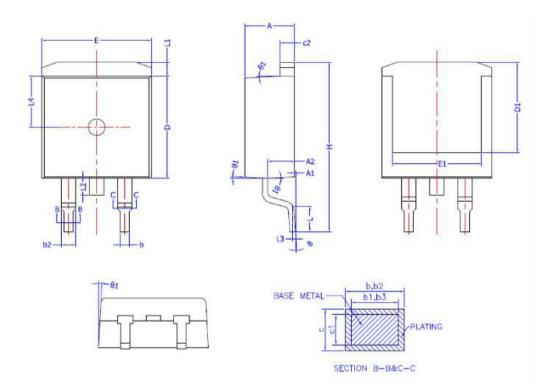
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-263-2L Package Information

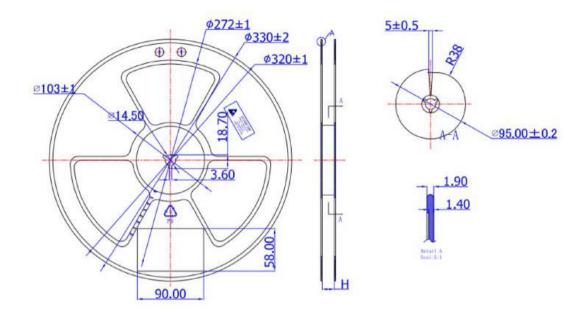


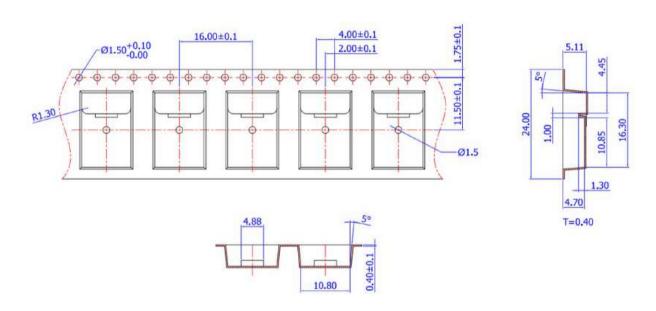
COMMON DIMENSIONS
(UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	4.40	4.50	4.60	
A1	0	0.10	0.25	
A2	2,20	2,40	2,60	
b	0,76	_	0,89	
b1	0.75	0,80	0,85	
b2	1,23	_	1,37	
b3	1,22	1,27	1,32	
С	0.47		0,60	
c1	0.46	0,51	0.56	
c2	1.25	1.30	1,35	
D	9.10	9,20	9.30	
D1	8.00			
E	9.80	9,90	10.00	
E1	7.80		- 1 /-	
е	2.54 BSC			
H	14.90	15.30	15.70	
L	2.00	2,30	2.60	
L1	1.17	1.27	1.40	
L2	-	12 - 0	1,75	
L3	0.25BSC			
L4	4,60 REF			
θ	00	- ,	8°	
θ1	1°	3°	5°	

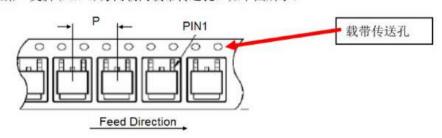






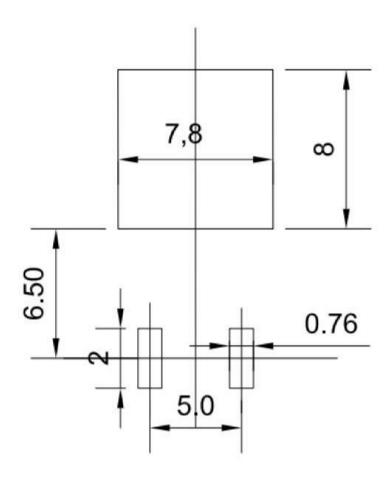


注:产品编入卷盘中时,产品第一支脚(PIN 1)方向朝向载带传送孔。如下图所示。





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